查询MCR8M供应商

捷多邦,专业PCB打样工厂,24小时加急出货

MCR8M, MCR8N

Preferred Device

Silicon Controlled Rectifiers

Reverse Blocking Thyristors

Designed primarily for half-wave ac control applications, such as motor controls, heating controls, and power supplies; or wherever half-wave, silicon gate-controlled devices are needed.

- Blocking Voltage of 600 thru 800 Volts
- On–State Current Rating of 8 Amperes RMS at 80°C
- High Surge Current Capability 80 Amperes
- Rugged, Economical TO220AB Package
- Glass Passivated Junctions for Reliability and Uniformity
- Minimum and Maximum Values of IGT, VGT and IH Specified for Ease of Design
- High Immunity to dv/dt 100 V/µsec Minimum at 125°C
- Device Marking: Logo, Device Type, e.g., MCR8N, Date Code

MAXIMUM RATINGS (TJ = 25°C unless otherwise noted)

Deting	Cumhal	Value	Unit
Rating	Symbol	value	Unit
Peak Repetitive Off-State Voltage(1) (TJ = -40 to 125°C, Sine Wave, 50 to 60 Hz, Gate Open) MCR8M MCR8N	Vdrm, Vrrm	600 800	Volts
On-State RMS Current (180° Conduction Angles; T _C = 80°C)	IT(RMS)	8.0	Amps
Peak Non-Repetitive Surge Current (One Full Cycle, 60 Hz, T _C = 125°C)	ITSM	80	Amps
Circuit Fusing Consideration (t = 8.33 ms)	l ² t	26.5	A ² sec
Forward Peak Gate Power (Pulse Width ≤ 1.0 μs, T _C = 80°C)	PGM	5.0	Watts
Forward Average Gate Power (t = 8.3 ms, $T_C = 80^{\circ}C$)	PG(AV)	0.5	Watt
Forward Peak Gate Current (Pulse Width ≤ 1.0 μs, T _C = 80°C)	IGM	2.0	Amps
Operating Junction Temperature Range	ТJ	-40 to 125	°C
Storage Temperature Range	T _{stg}	-40 to 150	°C

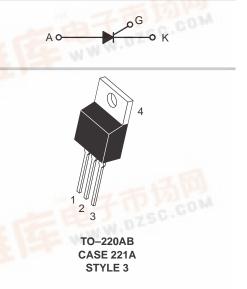
(1) V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.



ON Semiconductor

http://onsemi.com

SCRs 8 AMPERES RMS 600 thru 800 VOLTS



PIN ASSIGNMENT				
1	1 Cathode			
2	Anode			
3	Gate			
4	Anode			

ORDERING INFORMATION

Device	Package	Shipping
MCR8M	TO220AB	50 Units/Rail
MCR8N	TO220AB	50 Units/Rail

Preferred devices are recommended choices for future use and best overall value.



THERMAL CHARACTERISTICS

Characteristic	Symbol	Value 2.2 62.5		Unit °C/W	
Thermal Resistance — Junction to Case — Junction to Ambient	R _{θJC} R _{θJA}				
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds			260		°C
ELECTRICAL CHARACTERISTICS (T _J = 25°C unless otherwise noted)				-
Characteristic	Symb	ol Min	Тур	Мах	Unit
OFF CHARACTERISTICS					-
Peak Repetitive Forward or Reverse Blocking Current $(V_D = Rated V_{DRM} and V_{RRM}; Gate Open)$ $T_J = 25^{\circ}C$ $T_J = 125^{\circ}C$	IDRM IRRM			0.01 2.0	mA
ON CHARACTERISTICS					
Peak Forward On–State Voltage* (I _{TM} = 16 A)		—	—	1.8	Volts
Gate Trigger Current (Continuous dc) $(V_D = 12 \text{ V}; \text{ R}_L = 100 \Omega)$	IGT	2.0	7.0	15	mA
Holding Current (V _D = 12 V, Gate Open, Initiating Current = 200 mA)	Ч	4.0	17	30	mA
Latch Current $(V_D = 12 \text{ V}, \text{ I}_G = 15 \text{ mA})$	١Ľ	6.0	20	40	mA
Gate Trigger Voltage (Continuous dc) (V _D = 12 V; 100 Ω) T _J = 25°C	VGT	0.5	0.65	1.0	Volts
Gate Non–Trigger Voltage $(V_D = 12 \text{ V}; \text{ R}_L = 100 \Omega)$ $T_J = 125^{\circ}\text{C}$	V _{GD}	0.2	-	—	Volts
DYNAMIC CHARACTERISTICS	•	!		•	
Critical Rate of Rise of Off–State Voltage (V _D = Rated V _{DRM} , Exponential Waveform, Gate Open, T _J = 125°C)	dv/dt	100	250	—	V/µs
Critical Rate of Rise of On–State Current IPK = 50 A, Pw = 40 μsec, diG/dt = 1 A/μsec, Igt = 50 mA	di/dt	—	-	50	A/μs

*Indicates Pulse Test: Pulse Width \leq 2.0 ms, Duty Cycle \leq 2%.

Voltage Current Characteristic of SCR

Symbol	Parameter			[⊢] Vтм	
/DRM	Peak Repetitive Off State Forward Voltage		-		
DRM	Peak Forward Blocking Current		on state		
/RRM	Peak Repetitive Off State Reverse Voltage	IRRM at VRRM			
RRM	Peak Reverse Blocking Current				
/тм	Peak On State Voltage				+ Voltage
<u>H</u>	Holding Current	Reverse Blockir (off state Reverse Avalanch Anode –	e) Foi	UDRM ward Blocking F (off state)	at VDRM Region
125					
120		P(AV), AVERAGE POWER DISSIPATION (WATTS) P(AV), AVERAGE POWER DISSIPATION (WATTS) 0 0 7 9 8 01 11 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1			180°
115				60°	0°
110		Å 12			\prec
		∭ 10 –	30°		
105				///	
100					
95	+ $+$ $+$ $+$ $+$ $+$ $+$ $+$	2			
90					
0	1 2 3 4 5 6 7	8 4 0	1 2 3	4 5	6 7
l	I _{T(RMS)} , RMS ON–STATE CURRENT (AMPS)	rt ک	Γ(AV), AVERAGE (ON-STATE CUP	RRENT (AMPS
	Figure 1. Typical RMS Current Derating	_	Figure 2. On-S	State Power D	Dissipation
00	$MUM @ T_J = 25^{\circ}C$ $MAXIMUM @ T_J = 125$	50 6ATE TRIGGER CURRENT (mA) 7 9 9 9 10 8 17 18 17 18 17 18 17 18 17 18 17 18 19 10 11 12 13 14 17 18 11 11 12 13 14 14 15 16 17 18 11 12 13 14 14 15 16 17 18 19 10 10 14 14 15 16 17 18 10 10 11 12 14 15 16 17 17			
.1	1.0 1.5 2.0 2.5	3.0 -40 -2	25 - 10 5 20	35 50 65	80 95 110

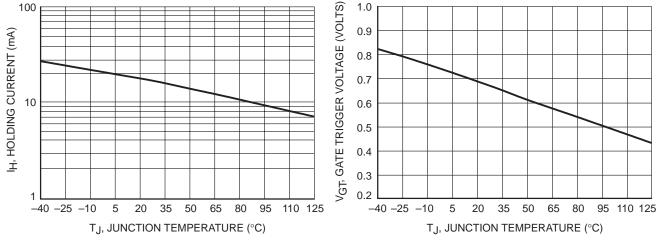
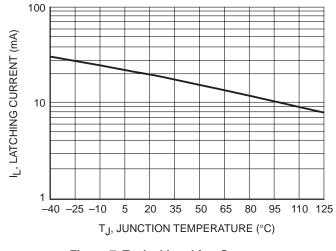




Figure 6. Typical Gate Trigger Voltage versus Junction Temperature

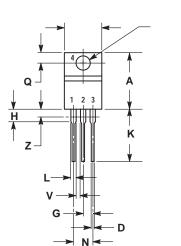


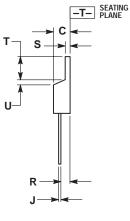


PACKAGE DIMENSIONS

TO-220AB

CASE 221A-09 ISSUE Z





NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES		MILLIN	ETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.570	0.620	14.48	15.75	
В	0.380	0.405	9.66	10.28	
С	0.160	0.190	4.07	4.82	
D	0.025	0.035	0.64	0.88	
F	0.142	0.147	3.61	3.73	
G	0.095	0.105	2.42	2.66	
Н	0.110	0.155	2.80	3.93	
J	0.018	0.025	0.46	0.64	
К	0.500	0.562	12.70	14.27	
L	0.045	0.060	1.15	1.52	
Ν	0.190	0.210	4.83	5.33	
Q	0.100	0.120	2.54	3.04	
R	0.080	0.110	2.04	2.79	
S	0.045	0.055	1.15	1.39	
Т	0.235	0.255	5.97	6.47	
U	0.000	0.050	0.00	1.27	
V	0.045		1.15		
Ζ		0.080		2.04	

STYLE 3: PIN 1. CATHODE 2. ANODE 3. GATE 4. ANODE

<u>Notes</u>

<u>Notes</u>

ON Semiconductor and III are trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer.

PUBLICATION ORDERING INFORMATION

NORTH AMERICA Literature Fulfillment: Literature Distribution Center for ON Semiconductor

P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: ONlit@hibbertco.com Fax Response Line: 303-675-2167 or 800-344-3810 Toll Free USA/Canada

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

- EUROPE: LDC for ON Semiconductor European Support
- German Phone: (+1) 303-308-7140 (M-F 1:00pm to 5:00pm Munich Time) Email: ONlit-german@hibbertco.com
- Phone: (+1) 303-308-7141 (M-F 1:00pm to 5:00pm Toulouse Time) French Email: ONlit-french@hibbertco.com
- English Phone: (+1) 303-308-7142 (M-F 12:00pm to 5:00pm UK Time) Email: ONlit@hibbertco.com

EUROPEAN TOLL-FREE ACCESS*: 00-800-4422-3781

*Available from Germany, France, Italy, England, Ireland

CENTRAL/SOUTH AMERICA:

- Spanish Phone: 303-308-7143 (Mon-Fri 8:00am to 5:00pm MST) Email: ONlit-spanish@hibbertco.com
- ASIA/PACIFIC: LDC for ON Semiconductor Asia Support Phone: 303-675-2121 (Tue-Fri 9:00am to 1:00pm, Hong Kong Time) Toll Free from Hong Kong & Singapore: 001-800-4422-3781 Email: ONlit-asia@hibbertco.com

JAPAN: ON Semiconductor, Japan Customer Focus Center 4-32-1 Nishi-Gotanda, Shinagawa-ku, Tokyo, Japan 141-8549 Phone: 81-3-5740-2745 Email: r14525@onsemi.com

ON Semiconductor Website: http://onsemi.com

For additional information, please contact your local Sales Representative.